



J320 2.5" SATA III 6Gb/s



Product Datasheet

Version 1.3

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Product Overview

- | | |
|--|--|
| <ul style="list-style-type: none">● Capacity<ul style="list-style-type: none">■ 30/32GB up to 960/1024GB● SATA Interface<ul style="list-style-type: none">■ SATA Revision 3.2■ SATA 1.5Gbps, 3Gbps, and 6Gbps interface● Flash Interface<ul style="list-style-type: none">■ Flash type: TLC/QLC■ 1pcs to 8pcs of TSOP and BGA flash● Performance<ul style="list-style-type: none">■ Read: up to 550 MB/s■ Write: up to 500 MB/s● Power Consumption^{Note1}<ul style="list-style-type: none">■ Active mode: < 2,120 mW■ Idle mode: < 365 mW■ DEVSLP mode: < 5 mW | <ul style="list-style-type: none">● MTBF<ul style="list-style-type: none">■ More than 2,000,000 hours● Advanced Flash Management<ul style="list-style-type: none">■ Static and Dynamic Wear Leveling■ Bad Block Management■ TRIM■ SMART■ Over-Provision■ Firmware Update■ SmartZIP™● Low Power Management<ul style="list-style-type: none">■ DIPM/HIPM Mode● Temperature Range<ul style="list-style-type: none">■ Operation: 0°C ~ 70°C■ Storage: -40°C ~ 85°C● RoHS compliant |
|--|--|

Notes:

1. Please see "4.2 Power Consumption" for details.

Performance and Power Consumption

Capacity	Flash Structure	Performance				Power Consumption		
		CrystalDiskMark		ATTO		Read (mW)	Write (mW)	DEVSLP (mW)
		Read (MB/s)	Write (MB/s)	Read (MB/s)	Write (MB/s)			
120/128GB	32GBx4, TSOP, K1C 15nm	550	450	560	540	1,280	1,830	4.9
240/256GB	64GBx4, TSOP, K1C 15nm	550	450	560	540	1,525	1,945	4.9
120/128GB	128GBx1, BGA, K1C 15nm	550	460	560	540	1,430	1,850	4.9
240/256GB	256GBx1, BGA, K1C 15nm	550	460	560	540	1,450	1,900	4.9
480/512GB	256GBx2, BGA, K1C 15nm	540	485	560	540	1,750	1,985	4.9
120GB	32GBx4, BGA, Hynix 16nm	550	350	560	540	1,710	1,930	4.9
120GB	64GBx2, BGA, Hynix 16nm	550	360	560	540	1,600	1,800	4.9
120/128GB	32GBx4, TSOP, Hynix 16nm	550	380	560	540	1,495	1,695	4.9
240/256GB	64GBx4, TSOP, Hynix 16nm	550	480	560	540	1,485	1,950	4.9
32GB	32GBx1, TSOP, K1C Bics2	290	90	560	540	1,185	1,290	4.9
60/64GB	32GBx2, TSOP, K1C Bics2	550	175	560	540	1,295	1,375	4.9
120/128GB	64GBx2, TSOP, K1C Bics2	550	350	560	540	1,365	1,420	4.9
240/256GB	64GBx4, TSOP, K1C Bics2	550	490	560	540	1,430	1,720	4.9
480/512GB	128GBx4, TSOP, K1C Bics2	550	490	560	540	1,710	1,985	4.9
30/32GB	32GBx1, TSOP, K1C Bics3	300	125	560	540	1,000	950	4.9
60/64GB	32GBx2, TSOP, K1C Bics3	550	255	560	540	1,230	1,000	4.9
240/256GB	32GBx8, TSOP, K1C Bics3	550	490	560	540	1,620	1,750	4.9
120/128GB	64GBx2, TSOP, K1C Bics3	550	450	560	540	1,600	1,720	4.9
240/256GB	64GBx4, TSOP, K1C Bics3	550	490	560	540	1,620	1,750	4.9
240/256GB	128GBx2, TSOP, K1C Bics3	550	490	560	540	1,620	1,750	4.9
480/512GB	128GBx4, TSOP, K1C Bics3	550	490	560	540	1,700	1,850	4.9
960/1024GB	128GBx8, TSOP, K1C Bics3	540	490	560	540	2,000	1,950	4.9
30/32GB	32GBx1, TSOP, K1C Bics4	305	135	560	540	1,280	1,100	4.9
60/64GB	32GBx2, TSOP, K1C Bics4	540	280	560	540	1,300	1,150	4.9
120/128GB	32GBx4, TSOP, K1C BiCS4	540	445	560	540	1,680	1,800	4.9
120/128GB	64GBx2, TSOP, K1C BiCS4	540	445	560	540	1,600	1,720	4.9
240/256GB	64GBx4, TSOP, K1C BiCS4	550	500	560	540	1,620	1,750	4.9
120/128GB	64GBx2, BGA, K1C Bics3	550	450	560	540	1,600	1,720	4.9
240/256GB	128GBx2, BGA, K1C Bics3	550	490	560	540	1,620	1,750	4.9
480/512GB	256GBx2, BGA, K1C Bics3	550	490	560	540	1,700	1,850	4.9
960/1024GB	256GBx4, BGA, K1C Bics3	540	490	560	540	2,000	1,950	4.9
120/128GB	64GBx2, BGA, K1C Bics4	540	445	560	540	1,600	1,720	4.9

120/128GB	128GBx1, BGA, KIC Bics4	540	445	560	540	1,600	1,720	4.9
240/256GB	64GBx4, BGA, KIC Bics4	550	500	560	540	1,620	1,750	4.9
240/256GB	128GBx2, BGA, KIC Bics4	550	500	560	540	1,620	1,750	4.9
480/512GB	128GBx4, BGA, KIC Bics4	540	490	560	540	1,850	2,000	4.9
480/512GB	256GBx2, BGA, KIC Bics4	540	490	560	540	1,900	2,000	4.9
960/1024GB	256GBx4, BGA, KIC Bics4	540	485	560	540	2,100	2,100	4.9
120/128GB	48GBx1+96GBx1, BGA, Micron B0KB	500	390	560	540	1,465	1,710	4.9
240/256GB	48GBx2+96GBx2, BGA, Micron B0KB	550	490	560	540	1,530	1,885	4.9
240GB	48GBx1+192GBx1, BGA, Micron B0KB	550	410	560	540	1,530	1,890	4.9
240GB	96GBx1+144GBx1, BGA, Micron B0KB	550	400	560	540	1,450	1,820	4.9
90GB	96GBx1, BGA Micron B0KB	460	350	560	540	1,200	1,500	4.9
120/128GB	144GBx1, BGA Micron B0KB	500	400	560	540	1,210	1,550	4.9
30/32GB	32GBx1, BGA, Micron B16A	300	120	560	540	1,450	1,300	4.9
60/64GB	32GBx2, BGA, Micron B16A	550	200	560	540	1,550	1,350	4.9
120/128GB	32GBx4, BGA, Micron B16A	550	405	560	540	1,490	1,590	4.9
120/128GB	64GBx2, BGA, Micron B16A	550	405	560	540	1,450	1,570	4.9
240/256GB	64GBx4, BGA, Micron B16A	540	475	560	540	1,270	1,675	4.9
240/256GB	128GBx2, BGA, Micron B16A	540	475	560	540	1,270	1,675	4.9
480/512GB	128GBx4, BGA, Micron B16A	530	440	560	540	1,550	1,850	4.9
240/256GB	144GBx2, BGA, Spectek B0KB	540	490	560	540	1,470	1,820	4.9
480/512GB	144GBx4, BGA, Spectek B0KB	550	490	560	540	1,560	2,120	4.9
240/256GB	64GBx4, BGA, Micron B17A	550	480	560	540	1,640	1,690	4.9
480/512GB	256GBx2, BGA, Micron B17A	550	480	560	540	1,640	1,690	4.9
480/512GB	512GBx1, BGA, Micron B17A	550	480	560	540	1,535	1,935	4.9
120/128GB	64GBx2, BGA, Micron B27A	550	495	560	540	1,400	1,450	4.9
120/128GB	128GBx1, BGA, Micron B27A	550	495	560	540	1,400	1,450	4.9
240/256GB	64GBx4, BGA, Micron B27A	550	500	560	540	1,300	1,500	4.9
240/256GB	128GBx2, BGA, Micron B27A	550	500	560	540	1,300	1,500	4.9
240/256GB	256GBx1, BGA, Micron B27A	550	500	560	540	1,300	1,500	4.9
480/512GB	256GBx2, BGA, Micron B27A	550	510	560	540	1,350	1,600	4.9
480/512GB	64GBx8, BGA, Micron B27A	550	510	560	540	1,350	1,600	4.9
960/1024GB	256GBx4, BGA, Micron B27A	550	510	560	540	1,500	1,750	4.9
30/32GB	32GBx1, BGA, Hynix V4	150	110	560	540	1,050	1,400	4.9
60/64GB	32GBx2, BGA, Hynix V4	300	220	560	540	1,100	1,500	4.9
120/128GB	128GBx1, BGA, Hynix V4	520	420	560	540	1,150	1,550	4.9
120/128GB	64GBx2, BGA, Hynix V4	520	420	560	540	1,160	1,560	4.9
240/256GB	64GBx4, BGA, Hynix V4	525	425	560	540	1,520	1,525	4.9

240/256GB	128GBx2, BGA, Hynix V4	525	425	560	540	1,500	1,600	4.9
480/512GB	256GBx2, BGA, Hynix V4	510	430	560	540	1,650	1,950	4.9
240/256GB	256GBx1, BGA, Micron N18A	550	445	560	540	1,600	1,650	4.9
480/512GB	256GBx2, BGA, Micron N18A	550	505	560	540	1,700	1,750	4.9
960/1024GB	256GBx4, BGA, Micron N18A	550	505	560	540	1,800	1,950	4.9
240/256GB	256GBx1, BGA, Micron N28A	550	430	560	540	1,300	1,450	4.9
480/512GB	256GBx2, BGA, Micron N28A	550	505	560	540	1,400	1,600	4.9
960/1024GB	256GBx4, BGA, Micron N28A	550	505	560	540	1,750	1,950	4.9

NOTE:

For more details on Power Consumption, please refer to Chapter 4.2.

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1. INTRODUCTION

1.1. General Description

J320 2.5" SATA III 6Gb/s SATA Solid State Disk (SSD) delivers all the advantages of flash disk technology with Serial ATA I/II/III interface, including being fully compliant with standard 2.5-inch form factor, providing low power consumption compared to traditional hard drive and hot-swapping when removing/replacing/upgrading flash disks. The device is designed based on the standard 7-pin interface for data segment and 15-pin for power segment, as well as operating at a maximum operating frequency of 200MHz with 30MHz external crystal. Its capacity could provide a wide range up to 1TB. Moreover, it can reach up to 550MB/s read as well as 500MB/s write high performance based on 16CE and Toggle 2.0 TLC flash (with 32MB SDR enabled and measured by CrystalDiskMark v5.0).

1.2. Controller Block Diagram

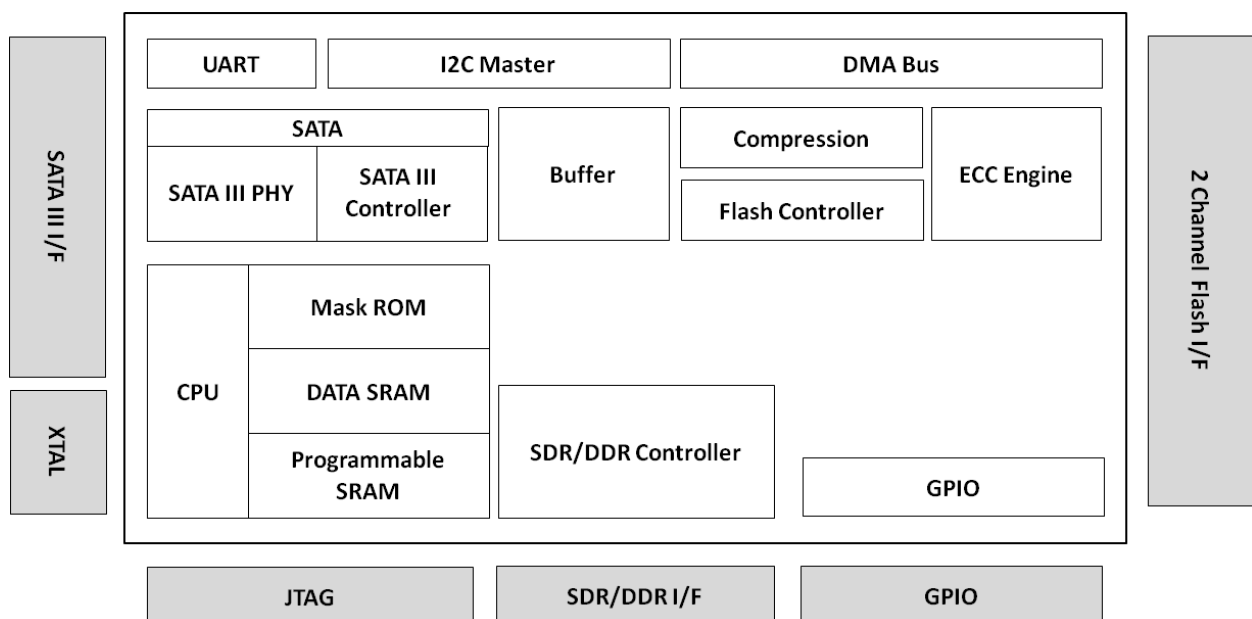


Figure 1-1 J320 2.5" SATA SSD Controller Block Diagram

1.3. Product Block Diagram

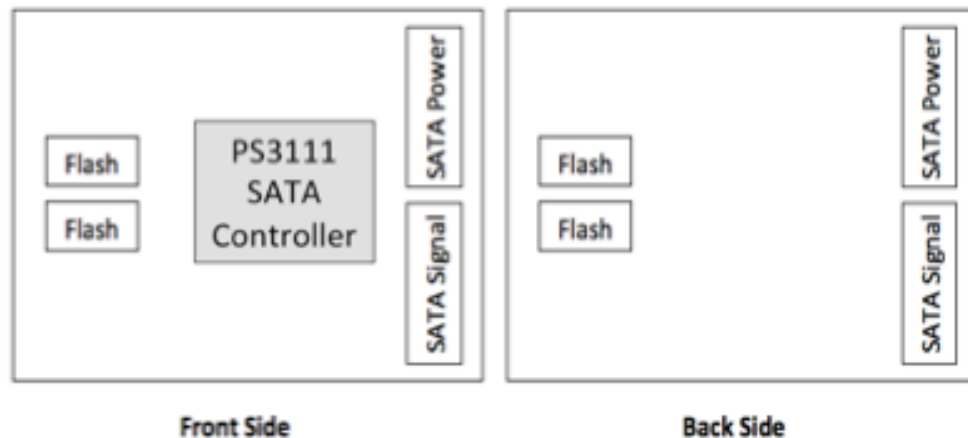


Figure 1-2 J320 2.5" SATA SSD Product Block Diagram

1.4. Flash Management

1.4.1. Error Correction Code (ECC)

Flash memory cells will deteriorate with use, which might generate random bit errors in the stored data. Thus, J320 2.5" SATA SSD applies the LDPC (Low Density Parity Check) of ECC algorithm, which can detect and correct errors occur during read process, ensure data been read correctly, as well as protect data from corruption.

1.4.2. Wear Leveling

NAND flash devices can only undergo a limited number of program/erase cycles, and in most cases, the flash media are not used evenly. If some areas get updated more frequently than others, the lifetime of the device would be reduced significantly. Thus, Wear Leveling is applied to extend the lifespan of NAND flash by evenly distributing write and erase cycles across the media.

J320 2.5" SATA provides advanced Wear Leveling algorithm, which can efficiently spread out the flash usage through the whole flash media area. Moreover, by implementing both dynamic and static Wear Leveling algorithms, the life expectancy of the NAND flash is greatly improved.

1.4.3. Bad Block Management

Bad blocks are blocks that include one or more invalid bits, and their reliability is not guaranteed. Blocks that are identified and marked as bad by the manufacturer are referred to as "Initial Bad Blocks". Bad blocks that are developed during the lifespan of the flash are named "Later Bad Blocks". J320 2.5 " SATA implements an efficient bad block management algorithm to detect the factory-produced bad blocks and manages any bad blocks that appear with use. This practice further prevents data being stored into bad blocks and improves the data reliability.

1.4.4. TRIM

TRIM is a feature which helps improve the read/write performance and speed of solid-state drives (SSD). Unlike hard disk drives (HDD), SSDs are not able to overwrite existing data, so the available space gradually becomes smaller with each use. With the TRIM command, the operating system can inform the SSD which blocks of data are no longer in use and can be removed permanently. Thus, the SSD will perform the erase action, which prevents unused data from occupying blocks all the time.

1.4.5. SMART

SMART, an acronym for Self-Monitoring, Analysis and Reporting Technology, is an open standard that allows a hard disk drive to automatically detect its health and report potential failures. When a failure is recorded by SMART, users can choose to replace the drive to prevent unexpected outage or data loss. Moreover, SMART can inform users of impending failures while there is still time to perform proactive actions, such as copy data to another device.

1.4.6. Over-Provision

Over Provisioning refers to the inclusion of extra NAND capacity in a SSD, which is not visible and cannot be used by users. With Over Provisioning, the performance and IOPS (Input/Output Operations per Second) are improved by providing the controller additional space to manage P/E cycles, which enhances the reliability and endurance as well. Moreover, the write amplification of the SSD becomes lower when the controller writes data to the flash.

1.4.7. Firmware Upgrade

Firmware can be considered as a set of instructions on how the device communicates with the host. Firmware will be upgraded when new features are added, compatibility issues are fixed, or read/write performance gets improved.

1.5. Low Power Management

1.5.1. DEVSLP Mode (Optional)

With the increasing need of aggressive power/battery life, SATA interfaces include a new feature, Device Sleep (DEVSLP) mode, which helps further reduce the power consumption of the device. DEVSLP enables the device to completely power down the device PHY and other sub-systems, making the device reach a new level of lower power operation. The DEVSLP does not specify the exact power level a device can achieve in the DEVSLP mode, but the power usage can be dropped down to 5mW or less.

1.5.2. DIPM/HIPM Mode

SATA interfaces contain two low power management states for power saving: Partial and Slumber modes. For Partial mode, the device has to resume to full operation within 10 microseconds, whereas the device will spend 10 milliseconds to become fully operational in the Slumber mode. SATA interfaces allow low power modes to be initiated by Host (HIPM, Host Initiated Power Management) or Device (DIPM, Device Initiated Power Management). As for HIPM, Partial or Slumber mode can be invoked directly by the software. For DIPM, the device will send requests to enter Partial or Slumber mode.

1.6. Power Loss Protection: Flushing Mechanism (Optional)

Power Loss Protection is a mechanism to prevent data loss during unexpected power failure. DRAM is a volatile memory and frequently used as temporary cache or buffer between the controller and the NAND flash to improve the SSD performance. However, one major concern of the DRAM is that it is not able to keep data during power failure. Accordingly, the J320 applies the **GuaranteedFlush** technology, which requests the controller to transfer data to the cache. For J320 2.5", SDR performs as a cache, and its size is 32MB. Only when the data is fully committed to the NAND flash will the controller send acknowledgement (ACK) to the host. Such implementation can prevent false-positive performance and the risk of power cycling issues.

Additionally, it is critical for a controller to shorten the time the in-flight data stays in the cache. Thus, J320 applies an algorithm to reduce the amount of data resides in the cache to provide a better performance. This

SmartCacheFlush technology allows incoming data to only have a “pit stop” in the cache and then move to the NAND flash at once. If the flash is jammed due to particular file sizes (such as random 4KB data), the cache will be treated as an “organizer”, consolidating incoming data into groups before written into the flash to improve write amplification.

In sum, with Flush Mechanism, J320 proves to provide the reliability required by consumer, industrial, and enterprise-level applications.

1.7. Advanced Device Security Features

1.7.1. Secure Erase

Secure Erase is a standard ATA command and will write all “0xFF” to fully wipe all the data on hard drives and SSDs. When this command is issued, the SSD controller will erase its storage blocks and return to its factory default settings.

1.7.2. Write Protect

When a SSD contains too many bad blocks and data are continuously written in, then the SSD might not be usable anymore. Thus, Write Protect is a mechanism to prevent data from being written in and protect the accuracy of data that are already stored in the SSD.

1.8. SSD Lifetime Management

1.8.1. Thermal Monitor (Optional)

Thermal monitors are devices for measuring temperature, and can be found in SSDs in order to issue warnings when SSDs go beyond a certain temperature. The higher temperature the thermal monitor detects, the more power the SSD consumes, causing the SSD to get aging quickly. Hence, the processing speed of a SSD should be under control to prevent temperature from exceeding a certain range. Meanwhile, the SSD can achieve power savings.

1.9. An Adaptive Approach to Performance Tuning

1.9.1. Throughput

Based on the available space of the disk, J320 will regulate the read/write speed and manage the

performance of throughput. When there still remains a lot of space, the firmware will continuously perform read/write action. There is still no need to implement garbage collection to allocate and release memory, which will accelerate the read/write processing to improve the performance. Contrarily, when the space is going to be used up, J320 will slow down the read/write processing, and implement garbage collection to release memory. Hence, read/write performance will become slower.

1.9.2. Predict & Fetch

Normally, when the host tries to read data from the SSD, the SSD will only perform one read action after receiving one command. However, J320 applies **Predict & Fetch** to improve the read speed. When the host issues sequential read commands to the SSD, the SSD will automatically expect that the following will also be read commands. Thus, before receiving the next command, flash has already prepared the data. Accordingly, this accelerates the data processing time, and the host does not need to wait so long to receive data.

1.9.3. SmartZIP™

Write data to the NAND Flash costs time. To improve the write speed performance, J320 launches with compression technique—SmartZIP™

Whether a file could be compressed or not depending on the file type, for file types have redundancy data pattern, through our embedded encode engine, we could reduce the amount of data that is actually written to the Flash. Comparing to the SSD without the compression, write efficiency is raised and the SSD endurance is also improved since Flash could be benefit from less data written for a longer SSD lifetime.

2. PRODUCT SPECIFICATIONS

- **Capacity**
 - From 30/32GB up to 960/1024GB (support 48-bit addressing mode)
- **Electrical/Physical Interface**
 - **SATA Interface**
 - ◆ Compliant with SATA Revision 3.2
 - ◆ Compatible with SATA 1.5Gbps, 3Gbps and 6Gbps interface
 - ◆ Support power management
 - ◆ Support expanded register for SATA protocol 48 bits addressing mode
 - ◆ Embedded BIST function for SATA PHY for low cost mass production
- **Built-in 2-channel NAND flash interface controller**
 - Compliant with Toggle 1.0 and Toggle 2.0 NAND Flash interface
 - Compliant with ONFI 4.0 interface:
 - ◆ SDR up to mode 5
 - ◆ NV-DDR up to mode 5
 - ◆ NV-DDR2 up to mode 7
 - ◆ NV-DDR3 up to mode 8
- **Supported NAND Flash**
 - Support up to 16 Flash Chip Enables (CE) within single design
 - K1C 24nm SLC; 15nm/3D-NAND MLC; 15nm/3D-NAND TLC
 - Intel/Micron 16nm/3D-NAND MLC and TLC
 - Hynix 16nm/V4/3D-NAND
 - Intel/Micron QLC NAND
 - Support all types of SLC/MLC/TLC/3D-NAND, 8KB/page and 16K/page NAND flash
 - Support ONFI 2.3, ONFI 3.0, ONFI 3.2 and ONFI 4.0 interface: 2 channels at maximum
 - Support 8-bit I/O NAND Flash
 - Contain 1pcs to 4pcs of TSOP/BGA flash
- **ECC Scheme**
 - J320 2.5"SSD applies the LDPC (Low Density Parity Check) of ECC algorithm.
- **UART function**
- **GPIO**

- Support SMART and TRIM commands
- Performance

Capacity	Flash Structure	Flash Type	Sequential	
			Read (MB/s)	Write (MB/s)
120/128GB	32GB x 4	TSOP, KIC 15nm	550	450
240/256GB	64GB x 4	TSOP, KIC 15nm	550	450
120/128GB	128GB x 1	BGA, KIC 15nm	550	460
240/256GB	256GB x 1	BGA, KIC 15nm	550	460
480/512GB	256GB x 2	BGA, KIC 15nm	540	485
120GB	32GB x 4	BGA, Hynix 16nm	550	350
120GB	64GB x 2	BGA, Hynix 16nm	550	360
120/128GB	32GB x 4	TSOP, Hynix 16nm	550	380
240/256GB	64GB x 4	TSOP, Hynix 16nm	550	480
30/32GB	32GB x 1	TSOP, KIC Bics2	290	90
60/64GB	32GB x 2	TSOP, KIC Bics2	550	175
120/128GB	64GB x 2	TSOP, KIC Bics2	550	350
240/256GB	64GB x 4	TSOP, KIC Bics2	550	490
480/512GB	128GB x 4	TSOP, KIC Bics2	550	490
30/32GB	32GB x 1	TSOP, KIC Bics3	300	125
60/64GB	32GB x 2	TSOP, KIC Bics3	550	255
240/256GB	32GB x 8	TSOP, KIC Bics3	550	490
120/128GB	64GB x 2	TSOP, KIC Bics3	550	450
240/256GB	64GB x 4	TSOP, KIC Bics3	550	490
240/256GB	128GB x 2	TSOP, KIC Bics3	550	490
480/512GB	128GB x 4	TSOP, KIC Bics3	550	490
960/1024GB	128GB x 8	TSOP, KIC Bics3	550	490
30/32GB	32GB x 1	TSOP, KIC Bics4	305	135
60/64GB	32GB x 2	TSOP, KIC Bics4	540	280
120/128GB	32GB x 4	TSOP, KIC Bics4	540	445
120/128GB	64GB x 2	TSOP, KIC Bics4	540	445
240/256GB	64GB x 4	TSOP, KIC Bics4	550	500
120/128GB	64GB x 2	BGA, KIC Bics3	550	450
240/256GB	128GB x 2	BGA, KIC Bics3	550	490
480/512GB	256GB x 2	BGA, KIC Bics3	550	490
960/1024GB	256GB x 4	BGA, KIC Bics3	540	490
120/128GB	64GB x 2	BGA, KIC Bics4	540	445
120/128GB	128GB x 1	BGA, KIC Bics4	540	445

240/256GB	64GB x 4	BGA, KIC Bics4	550	500
240/256GB	128GB x 2	BGA, KIC Bics4	550	500
480/512GB	128GB x 4	BGA, KIC Bics4	540	490
480/512GB	256GB x 2	BGA, KIC Bics4	540	490
960/1024GB	256GB x 4	BGA, KIC Bics4	540	485
120/128GB	48GB x 1+96GB x 1	BGA, Micron B0KB	500	390
240/256GB	48GB x 2+96GB x 2	BGA, Micron B0KB	550	490
240GB	48GB x 1 + 192GB x 1	BGA, Micron B0KB	550	410
240GB	96GB x 1 + 144GB x 1	BGA, Micron B0KB	550	400
90GB	96GB x 1	BGA, Micron B0KB	460	350
30/32GB	32GB x 1	BGA, Micron B16A	300	120
60/64GB	32GB x 2	BGA, Micron B16A	550	200
120/128GB	144GB x 1	BGA, Micron B0KB	500	400
120/128GB	32GB x 4	BGA, Micron B16A	550	405
120/128GB	64GB x 2	BGA, Micron B16A	550	405
240/256GB	64GB x 4	BGA, Micron B16A	540	475
240/256GB	128GB x 2	BGA, Micron B16A	540	475
480/512GB	128GB x 4	BGA, Micron B16A	530	440
240/256GB	144GB x 2	BGA, Spectek B0KB	540	490
480/512GB	144GB x 4	BGA, Spectek B0KB	550	490
240/256GB	64GB x 4	BGA, Micron B17A	550	480
480/512GB	256GB x 2	BGA, Micron B17A	550	480
480/512GB	512GB x 1	BGA, Micron B17A	550	480
120/128GB	64GB x 2	BGA, Micron B27A	550	495
120/128GB	128GB x 1	BGA, Micron B27A	550	495
240/256GB	64GB x 4	BGA, Micron B27A	550	500
240/256GB	128GB x 2	BGA, Micron B27A	550	500
240/256GB	256GB x 1	BGA, Micron B27A	550	500
480/512GB	256GB x 2	BGA, Micron B27A	550	510
480/512GB	64GB x 8	BGA, Micron B27A	550	510
960/1024GB	256GB x 4	BGA, Micron B27A	550	510
30/32GB	32GB x 1	BGA, Hynix V4	150	110
60/64GB	32GB x 2	BGA, Hynix V4	300	220
120/128GB	128GB x 1	BGA, Hynix V4	520	420
120/128GB	64GB x 2	BGA, Hynix V4	510	410
240/256GB	64GB x 4	BGA, Hynix V4	525	425
240/256GB	128GB x 2	BGA, Hynix V4	525	425
480/512GB	256GB x 2	BGA, Hynix V4	510	430
240/256GB	256GB x 1	BGA, Micron N18A	550	445

480/512GB	256GB x 2	BGA, Micron N18A	550	505
960/1024GB	256GB x 4	BGA, Micron N18A	550	505
240/256GB	256GB x 1	BGA, Micron N28A	550	430
480/512GB	256GB x 2	BGA, Micron N28A	550	505
960/1024GB	256GB x 4	BGA, Micron N28A	550	505

NOTES:

1. The performance was measured using CrystalDiskMarkv5.0x64 with SATA 6Gbps host.
2. Samples were built using K1C 15nm, B1C2, B1C3, B1C4, Hynix 16nm/V4 and Micron/Spectek B0KB/B16A/B17A/B27A/N18A/N28A NAND.
3. Performance may differ according to flash configuration and platform.
4. The table above is for reference only. The criteria for MP (mass production) and for accepting goods shall be discussed based on different flash configuration.

3. ENVIRONMENTAL SPECIFICATIONS

3.1. Environmental Conditions

3.1.1. Temperature and Humidity

- Temperature:
 - ◆ Storage: -40°C to 85°C
 - ◆ Operational: 0°C to 70°C
- Humidity: RH 90% under 40°C (operational)

Table 3-1 High Temperature Test Condition

	Temperature	Humidity	Test Time
Operation	70°C	0% RH	72 hours
Storage	85°C	0% RH	72 hours

Result: No any abnormality is detected.

Table 3-2 Low Temperature Test Condition

	Temperature	Humidity	Test Time
Operation	0°C	0% RH	72 hours
Storage	-40°C	0% RH	72 hours

Result: No any abnormality is detected.

Table 3-3 High Humidity Test Condition

	Temperature	Humidity	Test Time
Operation	40°C	90% RH	4 hours
Storage	40°C	93% RH	72 hours

Result: No any abnormality is detected.

Table 3-4 Temperature Cycle Test

	Temperature	Test Time	Cycle
Operation	0°C	30 min	10 Cycles
	70°C	30 min	
Storage	-40°C	30 min	10 Cycles
	85°C	30 min	

Result: No any abnormality is detected.

3.1.2. Shock

Table 3-5 J320 2.5" SATA SSD Shock Specification

	Acceleration Force	Half Sin Pulse Duration
Non-operational	1500G	0.5ms

Result: No any abnormality is detected when power on.

3.1.3. Vibration

Table 3-5 J320 2.5" SATA SSD Vibration Specification

	Condition		Vibration Orientation
	Frequency/Displacement	Frequency/Acceleration	
Non-operational	20Hz~80Hz/1.52mm	80Hz~2000Hz/20G	X, Y, Z axis/60 min for each

Result: No any abnormality is detected when power on.

3.1.4. Drop

Table 3-6 J320 2.5" SATA SSD Drop Specification

	Height of Drop	Number of Drop
Non-operational	80cm free fall	6 face of each unit

Result: No any abnormality is detected when power on.

3.1.5. Bending

Table 3-7 J320 2.5" SATA SSD Bending Specification

	Force	Action
Non-operational	≥ 50N	Hold 1min/5times

Result: No any abnormality is detected when power on.

3.1.6. Torque

Table 3-8 J320 2.5" SATA SSD Torque Specification

	Force	Action
Non-operational	1.263N-m or ±10 deg	Hold 1min/5times

Result: No any abnormality is detected when power on.

3.1.7. Electrostatic Discharge (ESD)

Table 3-9 J320 2.5" SATA SSD Contact ESD Specification

Device	Capacity	Temperature	Relative Humidity	+/- 4KV	Result
2.5" SSD	256GB	24.0°C	49% (RH)	Device functions are affected, but	PASS
	1024GB			EUT will be back to its normal or operational state automatically.	

3.1.8. EMI Compliance

- FCC: CISPR22 ; CISPR32
- CE: EN55022 ; EN55032
- BSMI 13438

3.2. MTBF

MTBF, an acronym for Mean Time Between Failures, is a measure of a device's reliability. Its value represents the average time between a repair and the next failure. The measure is typically in units of hours. The higher the MTBF value, the higher the reliability of the device. The predicted result of J320 2.5" SATA SSD is more than 2,000,000 hours.

3.3. Certification & Compliance

- RoHS
- SATA III (SATA Rev. 3.2)
- Up to ATA/ATAPI-8 (Including S.M.A.R.T)

4. ELECTRICAL SPECIFICATIONS

4.1. Supply Voltage

Table 4-1 Supply Voltage of J320 2.5" SATA SSD

Parameter	Rating	Range
Operating Voltage	5V	± 5%

4.2. Power Consumption

Table 4-2 Power Consumption of J320 2.5" SATA SSD

Capacity	Flash Structure	Flash Type	Read (mW)	Write (mW)	Partial (mW)	Slumber (mW)	Idle (mW)	DEVSLP (mW)
120/128GB	32GB x 4	TSOP, KIC 15nm	1,280	1,830	12	7	285	4.9
240/256GB	64GB x 4	TSOP, KIC 15nm	1,525	1,945	13.5	8	315	4.9
120/128GB	128GB x 1	BGA, KIC 15nm	1,430	1,850	20	17	350	4.9
240/256GB	256GB x 1	BGA, KIC 15nm	1,450	1,900	20	17	365	4.9
480/512GB	256GB x 2	BGA, KIC 15nm	1,750	1,985	21	17.5	365	4.9
120/128GB	32GB x 4	BGA, Hynix 16nm	1,710	1,930	20	16	325	4.9
120/128GB	64GB x 2	BGA, Hynix 16nm	1,600	1,800	19	14	310	4.9
120/128GB	32GB x 4	TSOP, Hynix 16nm	1,495	1,695	20	14	320	4.9
240/256GB	64GB x 4	TSOP, Hynix 16nm	1,485	1,950	19.5	14	315	4.9
30/32GB	32GB x 1	TSOP, KIC Bics2	1,185	1,290	19	15	315	4.9
60/64GB	32GB x 2	TSOP, KIC Bics2	1,295	1,375	19	15	315	4.9
120/128GB	64GB x 2	TSOP, KIC Bics2	1,365	1,420	19	15	315	4.9
240/256GB	64GB x 4	TSOP, KIC Bics2	1,430	1,720	19	15	315	4.9
480/512GB	128GB x 4	TSOP, KIC Bics2	1,710	1,985	19	15	315	4.9
30/32GB	32GB x 1	TSOP, KIC Bics3	1,000	950	19	15	325	4.9
60/64GB	32GB x 2	TSOP, KIC Bics3	1,230	1,000	20	14	320	4.9
240/256GB	32GB x 8	TSOP, KIC Bics3	1,620	1,750	22	16	325	4.9
120/128GB	64GB x 2	TSOP, KIC Bics3	1,600	1,720	20	14	320	4.9
240/256GB	64GB x 4	TSOP, KIC Bics3	1,620	1,750	20	14	325	4.9
240/256GB	128GB x 2	TSOP, KIC Bics3	1,620	1,750	19	14	315	4.9
480/512GB	128GB x 4	TSOP, KIC Bics3	1,700	1,850	22	16	320	4.9
960/1024GB	128GB x 8	TSOP, KIC Bics3	2,000	1,950	22	16	320	4.9
30/32GB	32GB x 1	TSOP, KIC Bics4	1,280	1,100	20	14	320	4.9
60/64GB	32GB x 2	TSOP, KIC Bics4	1,300	1,150	22	16	325	4.9

120/128GB	34GB x 4	TSOP, KIC BiCS4	1,680	1,800	20	13	325	4.9
120/128GB	64GB x 2	TSOP, KIC BiCS4	1,600	1,720	20	13	325	4.9
240/256GB	64GB x 4	TSOP, KIC BiCS4	1,620	1,750	19	15	320	4.9
120/128GB	64GB x 2	BGA, KIC Bics3	1,600	1,720	20	15	325	4.9
240/256GB	128GB x 2	BGA, KIC Bics3	1,620	1,750	21	15	320	4.9
480/512GB	256GB x 2	BGA, KIC Bics3	1,700	1,850	20	15	320	4.9
960/1024GB	256GB x 4	BGA, KIC Bics3	2,000	1,950	20	15	320	4.9
120/128GB	64GB x 2	BGA, KIC Bics4	1,600	1,720	21	15	320	4.9
120/128GB	128GB x 1	BGA, KIC Bics4	1,600	1,720	21	15	320	4.9
240/256GB	64GB x 4	BGA, KIC Bics4	1,620	1,750	22	16	325	4.9
240/256GB	128GB x 2	BGA, KIC Bics4	1,620	1,750	22	16	325	4.9
480/512GB	128GB x 4	BGA, KIC Bics4	1,850	2,000	22	15	335	4.9
480/512GB	256GB x 2	BGA, KIC Bics4	1,900	2,000	22	15	335	4.9
960/1024GB	256GB x 4	BGA, KIC Bics4	2,100	2,100	22	16	330	4.9
120/128GB	48GBx1 + 96GBx1	BGA, Micron B0KB	1,465	1,710	18	13	320	4.9
240/256GB	48GBx2 + 96GBx2	BGA, Micron B0KB	1,530	1,885	19	15	310	4.9
240/256GB	96GBx1 + 144GBx1	BGA, Micron B0KB	1,530	1,890	19	13	315	4.9
240/256GB	48GBx1 + 196GBx1	BGA, Micron B0KB	1,450	1,820	19	13	315	4.9
90GB	96GB x 1	BGA, Micron B0KB	1,200	1,500	19	14	310	4.9
120/128GB	144GB x 1	BGA, Micron B0KB	1,210	1,550	20	15	310	4.9
30/32GB	32GB x 1	BGA, Micron B16A	1,450	1,300	23	16	315	4.9
60/64GB	32GB x 2	BGA, Micron B16A	1,550	1,350	24	17	320	4.9
120/128GB	32GB x 4	BGA, Micron B16A	1,490	1,590	23	17	350	4.9
120/128GB	64GB x 2	BGA, Micron B16A	1,450	1,570	23	17	350	4.9
240/256GB	64GB x 4	BGA, Micron B16A	1,270	1,675	23	17	335	4.9
240/256GB	128GB x 2	BGA, Micron B16A	1,270	1,675	23	17	335	4.9
480/512GB	128GB x 4	BGA, Micron B16A	1,550	1,850	23	18	340	4.9
240/256GB	144GB x 2	BGA, Spectek B0KB	1,470	1,820	20	15	335	4.9
480/512GB	144GB x 4	BGA, Spectek B0KB	1,560	2,120	23	17	335	4.9
240/256GB	64GB x 4	BGA, Micron B17A	1,640	1,690	23	17	360	4.9
480/512GB	256GB x 2	BGA, Micron B17A	1,640	1,690	24	18	325	4.9
480/512GB	512GB x 1	BGA, Micron B17A	1,535	1,935	24	18	325	4.9
120/128GB	64GB x 2	BGA, Micron B27A	1,400	1,450	23	16	320	4.9
120/128GB	128GB x 1	BGA, Micron B27A	1,400	1,450	23	16	320	4.9
240/256GB	64GB x 4	BGA, Micron B27A	1,300	1,500	22	15	320	4.9
240/256GB	128GBx2	BGA, Micron B27A	1,300	1,500	22	15	320	4.9
240/256GB	256GB x 1	BGA, Micron B27A	1,300	1,500	22	15	320	4.9
480/512GB	256GB x 2	BGA, Micron B27A	1,350	1,600	22	16	310	4.9
480/512GB	64GB x 8	BGA, Micron B27A	1,350	1,600	22	16	310	4.9

960/1024GB	256GBx4	BGA, Micron B27A	1,500	1,750	22	16	310	4.9
30/32GB	32GB x 1	BGA, Hynix V4	1,050	1,400	23	16	320	4.9
60/64GB	32GB x 2	BGA, Hynix V4	1,100	1,500	23	16	320	4.9
120/128GB	128GB x 1	BGA, Hynix V4	1,150	1,550	25	17	350	4.9
120/128GB	64GB x 2	BGA, Hynix V4	1,160	1,560	25	17	350	4.9
240/256GB	64GB x 4	BGA, Hynix V4	1,520	1,525	25	17	335	4.9
240/256GB	128GB x 2	BGA, Hynix V4	1,500	1,600	25	17	335	4.9
480/512GB	256GB x 2	BGA, Hynix V4	1,650	1,950	25	18	335	4.9
240/256GB	256GB x 1	BGA, Micron N18A	1,600	1,650	24	17	320	4.9
480/512GB	256GB x 2	BGA, Micron N18A	1,700	1,750	23	17	335	4.9
960/1024GB	256GB x 4	BGA, Micron N18A	1,800	1,950	25	18	325	4.9
240/256GB	256GB x 1	BGA, Micron N28A	1,300	1,450	27	20	320	4.9
480/512GB	256GB x 2	BGA, Micron N28A	1,400	1,600	27	21	320	4.9
960/1024GB	256GB x 4	BGA, Micron N28A	1,750	1,950	26	20	325	4.9

NOTES:

1. The average value of power consumption is achieved based on 100% conversion efficiency.
2. The measured power voltage is 5V.
3. Samples were built using K1C 15nm, Bics2, Bics3, Bics4, Hynix 16nm/V4 and Micron/Spectek B0KB/B16A/B17A/B27A/N18A/N28A NAND. It's measured under ambient temperature.
4. Sequential R/W is measured while testing 4000MB sequential R/W 5 times by CrystalDiskMark. DEVSLP is measured while entering device sleep mode for 5 minutes.
5. Power Consumption may differ according to flash configuration and platform.

5. INTERFACE

5.1. Pin Assignment and Descriptions

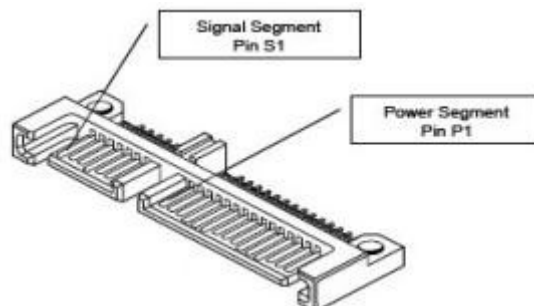


Figure 5-1 J320 2.5" SATA SSD Pin Assignment

Table 5-1 Signal Segment Pin Assignment and Descriptions

Pin Number	Function
S1	GND
S2	A+ (Differential Signal Pair A)
S3	A – (Differential Signal Pair A)
S4	GND
S5	B – (Differential Signal Pair B)
S6	B+ (Differential Signal Pair B)
S7	GND

Table 5-2 Power Segment Pin Assignment and Descriptions

Pin Number	Function
P1	Not Used (3.3V)
P2	Not Used (3.3V)
P3	DEVSLP
P4	GND
P5	GND
P6	GND
P7	5V pre-charge
P8	5V
P9	5V
P10	GND
P11	Reserved
P12	GND
P13	Not Used (12V pre-charge)
P14	Not Used (12V)
P15	Not Used (12V)

6. SUPPORTED COMMANDS

6.1. ATA Command List

The following ATA command list table is followed by ATA8-ACS4 SPEC.

Table 6-1 ATA Command List

Op Code	Description	Op Code			Description
00h	NOP	C9h			Read DMA without Retry
06h	Data Set Management	CAh			Write DMA
10h-1Fh	Recalibrate	CBh			Write DMA without Retry
20h	Read Sectors	CEh			Write Multiple FUA EXT
21h	Read Sectors without Retry	E0h			Standby Immediate
24h	Read Sectors EXT	E1h			Idle Immediate
25h	Read DMA EXT	E2h			Standby
27h	Read Native Max Address EXT	E3h			Idle
29h	Read Multiple EXT	E4h			Read Buffer
2Fh	Read Log EXT	E5h			Check Power Mode
30h	Write Sectors	E6h			Sleep
31h	Write Sectors without Retry	E7h			Flush Cache
34h	Write Sectors EXT	E8h			Write Buffer
35h	Write DMA EXT	E9h			READ BUFFER DMA
37h	Set Native Max Address EXT	EAh			Flush Cache EXT
38h	CFA Write Sectors Without Erase (Cfast Only)	EBh			Write Buffer DMA
39h	Write Multiple EXT	ECh			Identify Device
3Dh	Write DMA FUA EXT	EFh			Set Features
3Fh	Write Long EXT	EFh	02h		Enable volatile write cache
40h	Read Verify Sectors	EFh	03h		Set transfer mode
41h	Read Verify Sectors without Retry	EFh	05h		Enable the APM feature set
42h	Read Verify Sectors EXT	EFh	10h		Enable use of SATA features et
44h	Zero EXT	EFh	10h	02h	Enable DMA Setup FIS Auto-Activate optimization
45h	Write Uncorrectable EXT	EFh	10h	03h	Enable Device-initiated interface power state (DIPM) transitions
47h	Read Log DMA EXT	EFh	10h	06h	Enable Software Settings Preservation (SSP)
57h	Write Log DMA EXT	EFh	10h	07h	Enable Device Automatic Partial to Slumber transitions
60h	Read FPDMA Queued	EFh	10h	09h	Enable Device Sleep
61h	Write FPDMA Queued	EFh	55h		Disable read look-ahead
70h-7Fh	Seek	EFh	66h		Disable reverting to power-on defaults

Op Code		Description	Op Code		Description	
90h		Execute Device Diagnostic	EFh	82h	Disable volatile write cache	
91h		Initialize Device Parameters	EFh	85h	Disable the APM feature set	
92h		Download Microcode	EFh	90h	Disable use of SATA feature set	
93h		Download Microcode DMA	EFh	90h	02h	Disable DMA Setup FIS Auto-Activate optimization
B0h		SMART	EFh	90h	03h	Disable Device-initiated interface power state (DIPM) transitions
B0h	D0h	SMART READ DATA	EFh	90h	06h	Disable Software Settings Preservation (SSP)
B0h	D1h	SMART READ ATTRIBUTE THRESHOLDS	EFh	90h	07h	Disable Device Automatic Partial to Slumber transitions
B0h	D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE	EFh	90h	09h	Disable Device Sleep
B0h	D3h	SMART SAVE ATTRIBUTE VALUES	EFh	AAh		Enable read look-ahead
B0h	D4h	SMART EXECUTE OFF-LINE IMMEDIATE	EFh	CCh		Enable reverting to power-on defaults
B0h	D5h	SMART READ LOG	F1h		Security Set Password	
B0h	D6h	SMART WRITE LOG	F2h		Security Unlock	
B0h	D8h	SMART ENABLE OPERATIONS	F3h		Security Erase Prepare	
B0h	D9h	SMART DISABLE OPERATIONS	F4h		Security Erase Unit	
B0h	DAh	SMART RETURN STATUS	F5h		Security Freeze Lock	
B0h	DBh	SMART ENABLE/DISABLE AUTOMATIC OFF-LINE	F6h		Security Disable Password	
B1h		Device Configuration	F8h		Read Native Max Address	
B4h		Sanitize	F9h		Set Max Address	
C4h		Read Multiple	F9h	01h	SET MAX SET PASSWORD	
C5h		Write Multiple	F9h	02h	SET MAXLOCK	
C6h		Set Multiple Mode	F9h	03h	SET MAX UNLOCK	
C8h		Read DMA	F9h	04h	SET MAX FREEZE LOCK	

6.2. Identify Device Data

The following table details the sector data returned by the IDENTIFY DEVICE command of ATA8-ACS4 SPEC.

Table 6-2 List of Device Identification

Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
0	F	0040h	General configuration bit-significant information
1	X	*1	Obsolete
2	F	C837h	Specific configuration
3	X	0010h	Obsolete
4-5	X	00000000h	Retired
6	X	003Fh	Obsolete
7-8	X	00000000h	Reserved for assignment by the Compact Flash Association
9	X	0000h	Retired
10-19	V	Varies	Serial number (20 ASCII characters)
20-21	X	00000000h	Retired
22	X	0000h	Obsolete
23-26	V	Varies	Firmware revision (8 ASCII characters)
27-46	V	Varies	Model number (xxxxxxxx)
47	F	8010h	7:0- Maximum number of sectors transferred per interrupt on MULTIPLE commands
48	F	4000h	Trusted Computing feature set options(not support)
49	F	2F00h	Capabilities
50	F	4000h	Capabilities
51-52	X	00000000h	Obsolete
53	F	0007h	Words 88 and 70:64 valid
54	X	*1	Obsolete
55	X	0010h	Obsolete
56	X	003Fh	Obsolete
57-58	X	*2	Obsolete
59	F	0110h	Sanitize and Number of sectors transferred per interrupt on MULTIPLE commands
60-61	V	*3	Maximum number of sector (28bit LBA mode)
62	X	0000h	Obsolete

Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
63	F	0407h	Multi-word DMA modes supported/selected
64	F	0003h	PIO modes supported
65	F	0078h	Minimum Multiword DMA transfer cycle time per word
66	F	0078h	Manufacturer's recommended Multiword DMA transfer cycle time
67	F	0078h	Minimum PIO transfer cycle time without flow control
68	F	0078h	Minimum PIO transfer cycle time with IORDY flow control
69	F	1F00h	Additional Supported (support download microcode DMA)
70	X	0000h	Reserved
71-74	X	000000000000 0000h	Reserved for the IDENTIFY PACKET DEVICE command
75	F	001Fh	Queue depth
76	F	850Eh	Serial SATA capabilities
77	F	0006h	Serial ATA Additional Capabilities
78	F	004Ch	Serial ATA features supported
79	F	0040h	Serial ATA features enabled
80	F	0FF8h	Major Version Number
81	F	0000h	Minor Version Number
82	F	746Bh	Command set supported
83	F	7D01h	Command set supported
84	F	4163h	Command set/feature supported extension
85	F	7469h	Command set/feature enabled
86	F	BC01h	Command set/feature enabled
87	F	4163h	Command set/feature default
88	F	007Fh	Ultra DMA Modes
89	F	000Ah	Time required for security erase unit completion
90	F	001Eh	Time required for Enhanced security erase completion
91	F	0000h	Current advanced power management value
92	F	FFFEh	Master Password Revision Code
93	F	0000h	Hardware reset result. For SATA devices, word 93 shall be set to the value 0000h.

Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
94	X	0000h	Obsolete
95	F	0000h	Stream Minimum Request Size
96	F	0000h	Streaming Transfer Time – DMA
97	F	0000h	Streaming Access Latency – DMA and PIO
98-99	F	00000000h	Streaming Performance Granularity
100-103	V	*4	Maximum user LBA for 48 bit Address feature set
104	F	0000h	Streaming Transfer Time – PIO
105	F	0008h	Maximum number of 512-byte blocks per DATA SET MANAGEMENT command
106	F	4000h	Physical sector size/Logical sector size
107	F	0000h	Inter-seek delay for ISO-7779 acoustic testing in microseconds
108-111	V	Varies	World Wide Name
112-115	X	000000000000 0000h	Reserved
116	X	0000h	Reserved
117-118	F	00000000h	Words per logical Sector
119	F	401Ch	Supported settings
120	F	401Ch	Command set/Feature Enabled/Supported
121-126	X	0h	Reserved
127	X	0000h	Obsolete
128	F	0021h	Security status
129-140	V	Varies	Vendor specific
141	V	Varies	Vendor specific
142-159	V	Varies	Vendor specific
160	X	0000h	Reserved for CFA
161-167	X	0h	Reserved for CFA
168	V	Varies	Device Nominal Form Factor
169	F	0001h	DATA SET MANAGEMENT command is supported
170-173	F	000000000000 000 0h	Additional Product Identifier
174-175	X	00000000h	Reserved
176-205	F	0h	Current media serial number

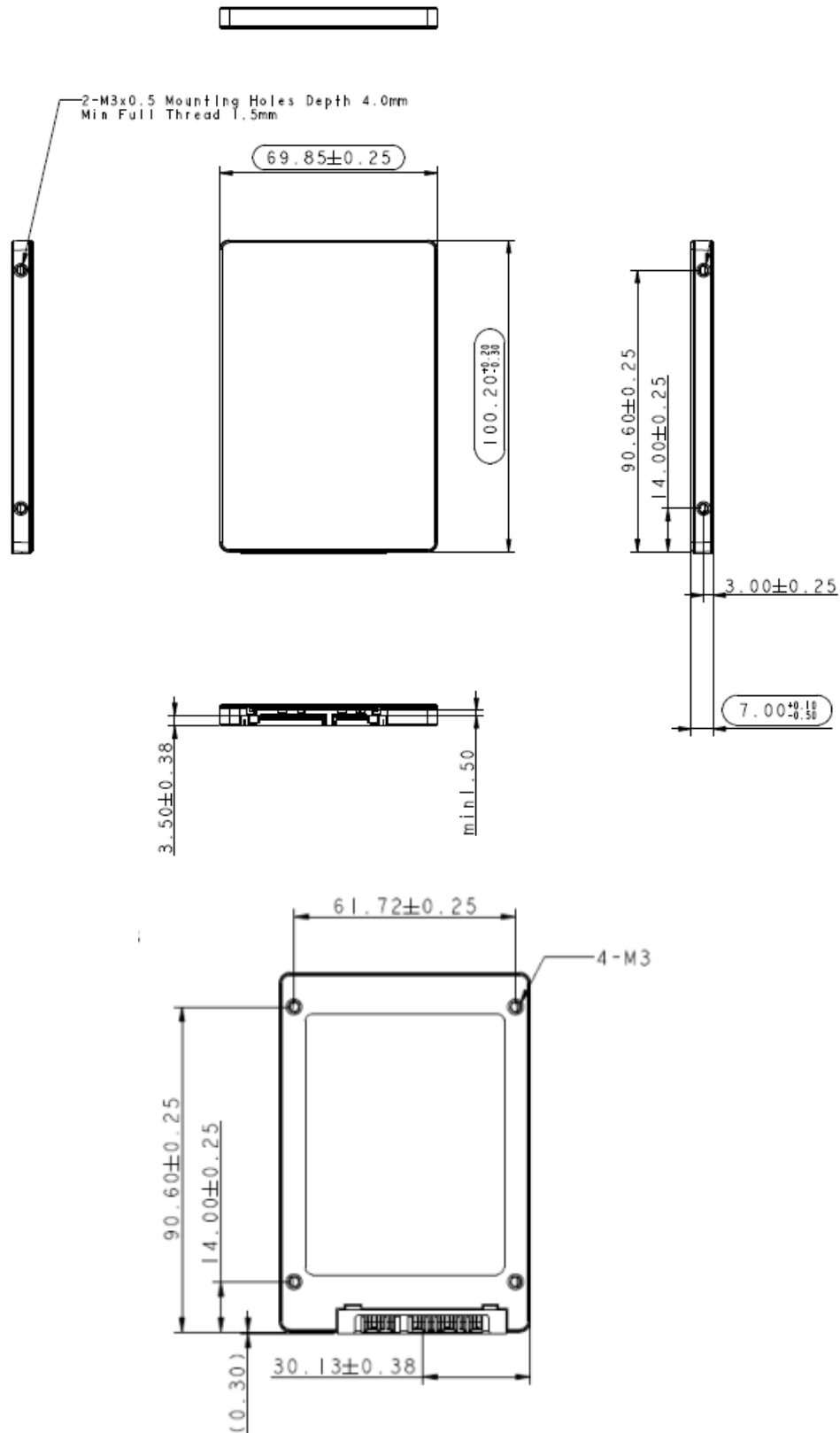
Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
206	F	0000h	SCT Command Transport
207-208	X	00000000h	Reserved
209	F	4000h	Alignment of logical blocks within a physical block
210-211	F	00000000h	Write-Read-Verify Sector Count Mode 3 (not support)
212-213	F	00000000h	Write-Read-Verify Sector Count Mode 2 (not support)
214-216	X	0h	Obsolete
217	F	0001h	Non-rotating media device
218	X	0000h	Reserved
219	X	0000h	NV Cache relate (not support)
220	V	0000h	Write read verify feature set current mode
221	X	0000h	Reserved
222	F	10FFh	Transport major version number
223	F	0000h	Transport minor version number
224-229	X	0h	Reserved
230-233	F	000000000000 0000h	Extend number of user addressable sectors
234	F	0001h	Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h
235	F	FFFEh	Maximum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h
236-254	X	0h	Reserved
255	F	XXA5h XX is variable	Integrity word (Checksum and Signature)

Table 6-3 List of Device Identification for Each Capacity

Capacity (GB)	*1 (Word 1/Word 54)	*2 (Word 57 – 58)	*3 (Word 60 – 61)	*4 (Word 100 – 103)
8	3CA5h	EEC9B0h	EEC9B0h	EEC9B0h
16	3FFFh	FBFC10h	1DD40B0h	1DD40B0h
32	3FFFh	FBFC10h	3BA2EB0h	3BA2EB0h
60	3FFFh	FBFC10h	6FCCF30h	6FCCF30h
64	3FFFh	FBFC10h	7740AB0h	7740AB0h
120	3FFFh	FBFC10h	DF94BB0h	DF94BB0h
128	3FFFh	FBFC10h	EE7C2B0h	EE7C2B0h
240	3FFFh	FBFC10h	FFFFFFFFh	1BF244B0h
256	3FFFh	FBFC10h	FFFFFFFFh	1DCF32B0h
480	3FFFh	FBFC10h	FFFFFFFFh	37E436B0h
512	3FFFh	FBFC10h	FFFFFFFFh	3B9E12B0
960	3FFFh	FBFC10h	FFFFFFFFh	6FC81AB0h
1024	3FFFh	FBFC10h	FFFFFFFFh	773BD2B0h

7. PHYSICAL DIMENSION

Dimension: 100mm (L) x 69.85mm (W) x 7.00mm (H)



8. TERMINOLOGY

The following table is to list out the acronyms that have been applied throughout the document.

Table 10-1 List of Terminology

Term	Definitions
ATTO	Commercial performance benchmark application
DIPM	Device initiated power management
HIPM	Host initiated power management
LBA	Logical block addressing
MB	Mega-byte
MTBF	Mean time between failures
NCQ	Native command queue
SATA	Serial advanced technology attachment
SDR	Synchronous dynamic access memory
S.M.A.R.T.	Self-monitoring, analysis and reporting technology
SSD	Solid state disk